



# Product Change Notification

**Change Notification #:** 117884 - 00

**Change Title:** Select Intel® SSD 660p Series Products, PCN 117884-00, Transport Media, Label, Package and Label Update

**Date of Publication:** November 23, 2020

## Key Characteristics of the Change:

Transport Media, Label

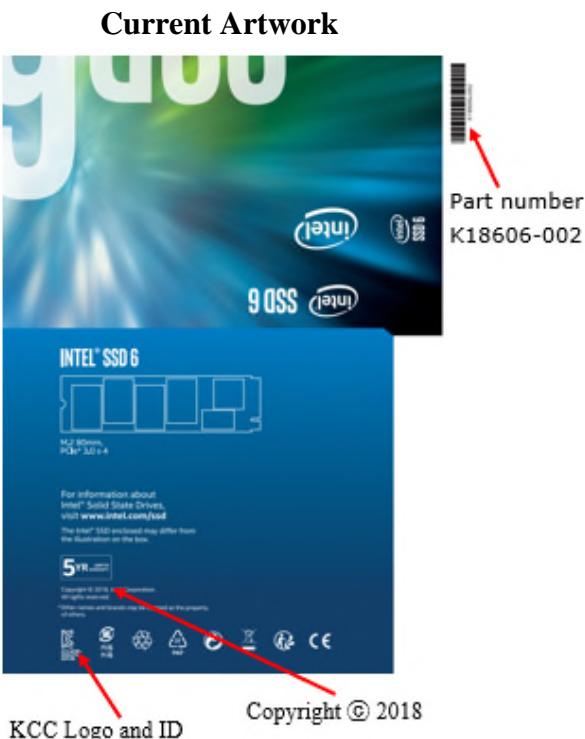
## Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	December 8, 2020
--	------------------

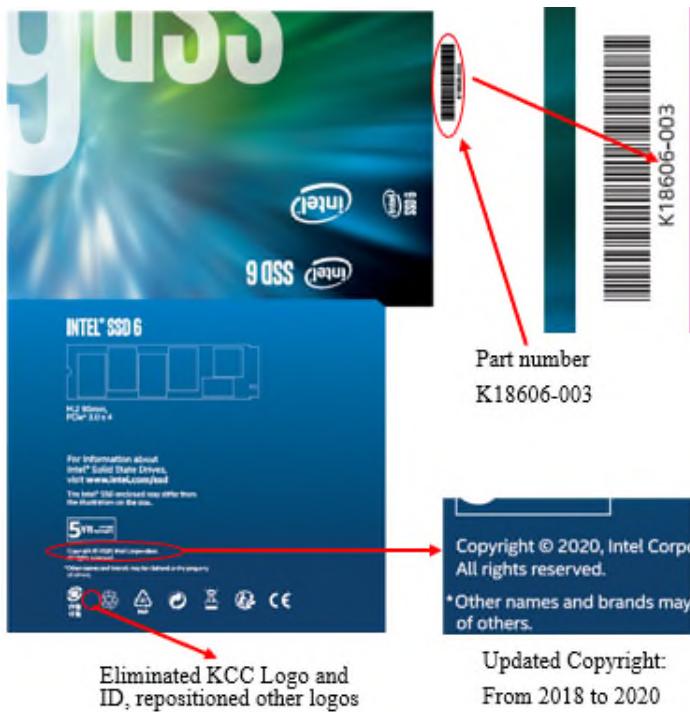
## Description of Change to the Customer:

Intel® SSD 660p Series Product SKUs listed in the Products Affected table below will have the following changes:

- Change 1: Box change to eliminate KCC logo from artwork
  - Part number change from K18606-002 to K18606-003
  - Remove KCC ID Logo and move to consumer unit label
  - Change Copyright date from 2018 to 2020



## New Artwork



- Change 2: Consumer Unit Label change
  - Add KCC logo and certification I.D. to label
  - Reposition various fields to allow for space on label

### Current Label



### New Label



Added KCC Logo (6mm)  
and ID number below on  
single line

Repositioned MFG Date,  
Version number and FW  
for fit

- Change 3: Structural packaging change
  - Remove corrugated "wallet" and clamshell
  - Replace with new clamshell packaging

**Current Clamshell**



**Remove:** H37250-001 Clamshell

**Current Wallet**



**Remove:** K29660-001 Corrugated Insert

**New Clamshell Packaging**



**Replace with:** K63022-001 Tray, K63019-001 Lid,  
and (2) K12257-001 Tamper labels over buttons

## **Customer Impact of Change and Recommended Action:**

There is no change to form fit or function, nor a change to Intel Ordering codes.

Intel will attempt to deplete pre-conversion material before shipping post-conversion material but there is a possibility of Intel shipping mixed inventory. Therefore, customers will need to manage and migrate to the post-conversion material as soon as possible.

Milestone dates are estimates and subject to change based on business and operational conditions.

Please contact your local Intel Field Sales Rep if you have any further questions about these changes.

## **Products Affected / Intel Ordering Codes:**

Marketing Name	Product Code	MM#
Intel® SSD 660p Series (512GB, M.2 80mm PCIe 3.0 x4, 3D2, QLC) Retail Box Single Pack	SSDPEKNW512G8X1	978348
Intel® SSD 660p Series (512GB, M.2 80mm PCIe 3.0 x4, 3D2, QLC) Retail Box 10 Pack	SSDPEKNW512G8XT	978349
Intel® SSD 660p Series (1.0TB, M.2 80mm PCIe 3.0 x4, 3D2, QLC) Retail Box Single Pack	SSDPEKNW010T8X1	978350
Intel® SSD 660p Series (2.0TB, M.2 80mm PCIe 3.0 x4, 3D2, QLC) Retail Box Single Pack	SSDPEKNW020T8X1	978351
Intel® SSD 660p Series (2.0TB, M.2 80mm PCIe 3.0 x4, 3D2, QLC) Retail Box 10 Pack	SSDPEKNW020T8XT	984872
Intel® SSD 660p Series (1.0TB, M.2 80mm PCIe 3.0 x4, 3D2, QLC) Retail Box 10 Pack	SSDPEKNW010T8XT	984875
Intel® SSD 665p Series (1.0TB, M.2 80mm PCIe 3.0 x4, 3D3, QLC) Retail Box Single Pack	SSDPEKNW010T9X1	999HHA
Intel® SSD 665p Series (2.0TB, M.2 80mm PCIe 3.0 x4, 3D3, QLC) Retail Box Single Pack	SSDPEKNW020T9X1	999HHG

## **PCN Revision History:**

### **Date of Revision:**

November 23, 2020

### **Revision Number:**

00

### **Reason:**

Originally Published PCN



# Product Change Notification

## 117884 - 00

INFORMATION IN THIS DOCUMENT IS PROVIDED IN CONNECTION WITH INTEL PRODUCTS. NO LICENSE, EXPRESS OR IMPLIED, BY ESTOPPEL OR OTHERWISE, TO ANY INTELLECTUAL PROPERTY RIGHTS IS GRANTED BY THIS DOCUMENT. EXCEPT AS PROVIDED IN INTEL'S TERMS AND CONDITIONS OF SALE FOR SUCH PRODUCTS, INTEL ASSUMES NO LIABILITY WHATSOEVER AND INTEL DISCLAIMS ANY EXPRESS OR IMPLIED WARRANTY, RELATING TO SALE AND/OR USE OF INTEL PRODUCTS INCLUDING LIABILITY OR WARRANTIES RELATING TO FITNESS FOR A PARTICULAR PURPOSE, MERCHANTABILITY, OR INFRINGEMENT OF ANY PATENT, COPYRIGHT OR OTHER INTELLECTUAL PROPERTY RIGHT.

A "Mission Critical Application" is any application in which failure of the Intel Product could result, directly or indirectly, in personal injury or death. SHOULD YOU PURCHASE OR USE INTEL'S PRODUCTS FOR ANY SUCH MISSION CRITICAL APPLICATION, YOU SHALL INDEMNIFY AND HOLD INTEL AND ITS SUBSIDIARIES, SUBCONTRACTORS AND AFFILIATES, AND THE DIRECTORS, OFFICERS, AND EMPLOYEES OF EACH, HARMLESS AGAINST ALL CLAIMS COSTS, DAMAGES, AND EXPENSES AND REASONABLE ATTORNEYS' FEES ARISING OUT OF, DIRECTLY OR INDIRECTLY, ANY CLAIM OF PRODUCT LIABILITY, PERSONAL INJURY, OR DEATH ARISING IN ANY WAY OUT OF SUCH MISSION CRITICAL APPLICATION, WHETHER OR NOT INTEL OR ITS SUBCONTRACTOR WAS NEGLIGENT IN THE DESIGN, MANUFACTURE, OR WARNING OF THE INTEL PRODUCT OR ANY OF ITS PARTS.

Intel may make changes to specifications and product descriptions at any time, without notice. Designers must not rely on the absence or characteristics of any features or instructions marked "reserved" or "undefined". Intel reserves these for future definition and shall have no responsibility whatsoever for conflicts or incompatibilities arising from future changes to them. The information here is subject to change without notice. Do not finalize a design with this information.

The products described in this document may contain design defects or errors known as errata which may cause the product to deviate from published specifications. Current characterized errata are available on request.

**Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.**

**Americas Contact:** [asmo.pcn@intel.com](mailto:asmo.pcn@intel.com)

**Asia Pacific/PRC Contact:** [apacgccb@intel.com](mailto:apacgccb@intel.com)

**Europe Email:** [eccb@intel.com](mailto:eccb@intel.com)

**Japan Email:** [jccb.ijkk@intel.com](mailto:jccb.ijkk@intel.com)

Copyright © Intel Corporation 2020. Other names and brands may be claimed as the property of others.

3D XPoint, ACEX, Altera, APEX, AnyWAN, Arria, Avalon, Axxia, BlueMoon, BunnyPeople, Celeron, Centrino, Cilk, CONVERGATE, Cyclone, Docea, eASIC, easicopy, Enpirion, Flexpipe, Hyperflex, Intel, the Intel logo, Intel Adaptx, Intel Agilex, Intel Atom, Intel CoFluent, Intel Core, Intel. Experience What's Inside, the Intel. Experience What's Inside logo, Intel Falcon, Intel Inside, the Intel Inside logo, Intel Nervana, Intel Optane, Intel RealSense, Intel Shooting Star, Intel Sirius, Intel SpeedStep, Intel Unite, Intel vPro, Intel Xeon Phi, Iris, Itanium, MAX, Movidius, Myriad, neon, Nios, OpenVINO, the OpenVINO logo, Pentium, Puma, Quark, Quartus, SICOFI, Simics, SMARTi, SoftSilicon, Sound Mark, StarPro, Stratix, the Stratix logo, Stay With It, the Engineering Stay With It logo, StreamSight, Tarari, The Journey Inside, Thunderbolt, the Thunderbolt logo, Transcede, Ultrabook, VTune, Xeon, X-GOLD, XMM, X-PMU and XPOSYS are trademarks of Intel Corporation or its subsidiaries in the U.S. and/or other countries.

Microsoft, Windows, and the Windows logo are trademarks, or registered trademarks of Microsoft Corporation in the United States and/or other countries. Java is a registered trademark of Oracle and/or its affiliates. Bluetooth is a trademark owned by its proprietor and used by Intel Corporation under license. Intel Corporation uses the Palm OS\* Ready mark under license from Palm, Inc. OpenCL and the OpenCL logo are trademarks of Apple Inc. used by permission by Khronos.

Learn how to use Intel Trademarks and Brands correctly at <http://www.intel.com/intel/legal/tmusage2.htm>.